

Accepted Manuscript

Mechanism on increased sheet formability induced by tangential adhesive stress in sheet flexible forming process employing viscoplastic pressure-carrying medium

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PII: S0890-6955(18)30085-3

DOI: [10.1016/j.ijmachtools.2018.04.008](https://doi.org/10.1016/j.ijmachtools.2018.04.008)

Reference: MTM 3344

To appear in: *International Journal of Machine Tools and Manufacture*

Received Date: 7 November 2017

Revised Date: 20 April 2018

Accepted Date: 24 April 2018

Please cite this article as: N. Xiang, Z.-j. Wang, S.-p. Cai, Mechanism on increased sheet formability induced by tangential adhesive stress in sheet flexible forming process employing viscoplastic pressure-carrying medium, *International Journal of Machine Tools and Manufacture* (2018), doi: 10.1016/j.ijmachtools.2018.04.008.

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